

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Aron T. Lunde

Application No.:

10/053,963

Filed:

January 22, 2002

For:

A DIE ASSEMBLY AND METHOD

FOR FORMING A DIE ON A

WAFER

Group Art Unit:

2823

Examiner:

Nguyen, Khiem D.

Atty. Docket: MICS:0214/FLE/MAN/EUB

01-0596

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 CERTIFICATE OF MAILING 37 C.F.R. 1.8

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:

May 2, 2007

Lee Eubanks IV

## AMENDMENT AND RESPONSE TO **OFFICE ACTION MAILED FEBRUARY 2, 2007**

Dear Sir:

In response to the Office Action mailed on February 2, 2007, Applicant respectfully requests reconsideration of the present application in view of the following amendments and remarks.